- **Members of the Texas Instruments** *Widebus*™ Family
- State-of-the-Art Advanced BiCMOS Technology (ABT) Design for 3.3-V **Operation and Low Static-Power** Dissipation
- Output Ports Have Equivalent 22- $\Omega$  Series Resistors, So No External Resistors Are Required
- **Support Mixed-Mode Signal Operation** (5-V Input and Output Voltages With 3.3-V V<sub>CC</sub>)
- **Support Unregulated Battery Operation** Down to 2.7 V
- **Typical V<sub>OLP</sub> (Output Ground Bounce)** <0.8 V at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$
- Ioff and Power-Up 3-State Support Hot Insertion
- Distributed V<sub>CC</sub> and GND Pins Minimize **High-Speed Switching Noise**
- Flow-Through Architecture Optimizes PCB
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- **ESD Protection Exceeds JESD 22** 
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)
- **Package Options Include Plastic Shrink** Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

NOTE: For tape and reel order entry:

The DGGR package is abbreviated to GR, and the DGVR package is abbreviated to VR.

## description

The 'LVT162240 devices are 16-bit buffers/drivers designed specifically for low-voltage (3.3-V) V<sub>CC</sub> operation and to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. They have the capability to provide a TTL interface to a 5-V system environment.

These devices can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer and provide inverting outputs and symmetrical active-low output-enable  $(\overline{OE})$  inputs.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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SN54LVT162240 . . . WD PACKAGE SN74LVT162240 . . . DGG, DGV, OR DL PACKAGE (TOP VIEW)

|                   |    | $\Box$ |    | L                 |
|-------------------|----|--------|----|-------------------|
| 10E [             | 1  | $\cup$ | 48 | 20E               |
| 1Y1 🛚             | 2  |        | 47 | ] 1A1             |
| 1Y2 🛚             | 3  |        | 46 | 1A2               |
| GND [             | 4  |        | 45 | GND               |
| 1Y3 L             | 5  |        | 44 | 1A3               |
| 1Y4 🛚             | 6  |        | 43 | ] 1A4             |
| V <sub>CC</sub>   | 7  |        | 42 | □ v <sub>cc</sub> |
| 2Y1 🛚             | 8  |        | 41 | 2A1               |
| 2Y2               | 9  |        | 40 | 2A2               |
| GND [             | 10 |        | 39 | GND               |
| 2Y3 🛚             | 11 |        | 38 | 2A3               |
| 2Y4 🛚             | 12 |        | 37 | ] 2A4             |
| 3Y1 [             | 13 |        | 36 | ] 3A1             |
| 3Y2 [             | 14 |        | 35 | ] 3A2             |
| GND [             | 15 |        | 34 | GND               |
| 3Y3 [             | 16 |        | 33 | ] 3A3             |
| 3Y4 🛚             | 17 |        | 32 | ] 3A4             |
| V <sub>CC</sub> [ | 18 |        | 31 | ] v <sub>cc</sub> |
| 4Y1 🛛             | 19 |        | 30 | ] 4A1             |
| 4Y2 🛚             | 20 |        | 29 | ] 4A2             |
| GND [             | 21 |        | 28 | GND               |
| 4Y3 [             | 22 |        | 27 | ] 4A3             |
| 4Y4 [             | 23 |        | 26 | ] 4A4             |
| 40E [             | 24 |        | 25 | 30E               |
|                   |    |        |    | l                 |

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## SN54LVT162240, SN74LVT162240 3.3-V ABT 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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#### description (continued)

The outputs, which are designed to source or sink up to 12 mA, include equivalent  $22-\Omega$  series resistors to reduce overshoot and undershoot.

When  $V_{CC}$  is between 0 and 1.5 V, the devices are in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

These devices are fully specified for hot-insertion applications using  $I_{off}$  and power-up 3-state. The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

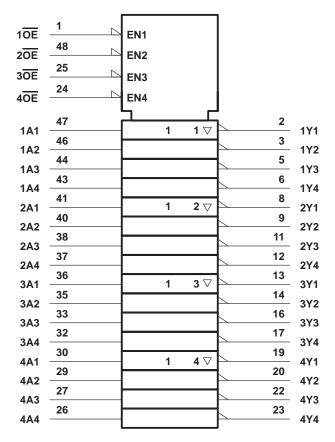
The SN54LVT162240 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74LVT162240 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE (each 4-bit buffer/driver)

| INP | JTS | OUTPUT |
|-----|-----|--------|
| OE  | Α   | Y      |
| L   | Н   | L      |
| L   | L   | Н      |
| н   | Χ   | Z      |

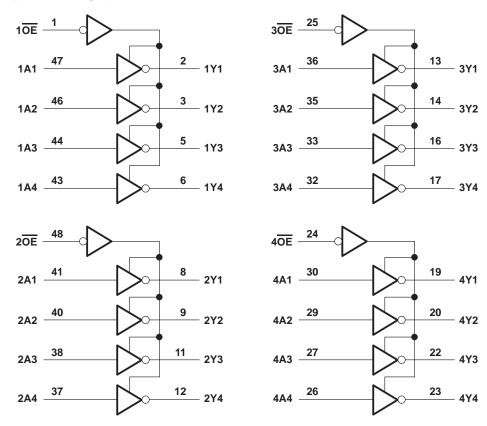


## logic symbol†



 $<sup>^\</sup>dagger$  This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V <sub>CC</sub>  | S   |
|--|-----|
| Input voltage range, V <sub>I</sub> (see Note 1)   | Į,  |
| Voltage range applied to any output in the high-impedance  | \   |
| or power-off state, V <sub>O</sub> (see Note 1)  |     |
| Voltage range applied to any output in the high state, $V_O$ (see Note 1)0.5 V to $V_{CC}$ + 0.5 V | \   |
| Current into any output in the low state, I <sub>O</sub>   | (   |
| Current into any output in the high state, I <sub>O</sub> (see Note 2)                             | (   |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )  | - I |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ )   | (   |
| Package thermal impedance, $\theta_{JA}$ (see Note 3): DGG package                                 | F   |
| DGV package 58°C/W   |     |
| DL package   |     |
| Storage temperature range, T <sub>stg</sub> —65°C to 150°C   | S   |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
  - 2. This current flows only when the output is in the high state and  $V_O > V_{CC}$ .
  - 3. The package thermal impedance is calculated in accordance with JESD 51.



## recommended operating conditions (see Note 4)

|                     |                                    | SN54LVT1        | 62240       | SN74LVT1 | UNIT |     |      |
|---------------------|------------------------------------|-----------------|-------------|----------|------|-----|------|
|                     |                                    |                 | MIN         | MAX      | MIN  | MAX | UNIT |
| VCC                 | Supply voltage                     | 2.7             | 3.6         | 2.7      | 3.6  | V   |      |
| VIH                 | High-level input voltage           |                 | 2           | , S      | 2    |     | V    |
| V <sub>IL</sub>     | Low-level input voltage            |                 | 0.8         |          | 0.8  | V   |      |
| VI                  | Input voltage                      |                 | 5.5         |          | 5.5  | V   |      |
| ІОН                 | High-level output current          |                 | 4           | -12      |      | -12 | mA   |
| loL                 | Low-level output current           |                 | 3           | 12       |      | 12  | mA   |
| Δt/Δν               | Input transition rise or fall rate | Outputs enabled | 000         | 10       |      | 10  | ns/V |
| Δt/ΔV <sub>CC</sub> | Power-up ramp rate                 |                 | 200         |          | 200  |     | μs/V |
| TA                  | Operating free-air temperature     |                 | <b>-</b> 55 | 125      | -40  | 85  | °C   |

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER         |                | TECT  | CONDITIONS                                  | SN5 | 4LVT162 | 2240  | SN7  | LINUT |            |      |
|-------------------|----------------|---|---|-----|---------|-------|------|-------|------------|------|
|                   |                | TEST CONDITIONS   |   |     | TYP†    | MAX   | MIN  | TYP†  | MAX        | UNIT |
| VIK               |                | $V_{CC} = 2.7 \text{ V},$   | I <sub>I</sub> = -18 mA                     |     |         | -1.2  |      |       | -1.2       | V    |
| Vон               |                | $V_{CC} = 3 V$ ,  | $I_{OH} = -12 \text{ mA}$                   | 2   |         |       | 2    |       |            | V    |
| VOL               |                | $V_{CC} = 3 V$ ,  | $I_{OL} = 12 \text{ mA}$                    |     |         | 0.8   |      |       | 0.8        | V    |
|                   |                | $V_{CC} = 0 \text{ or } 3.6 \text{ V},$   | V <sub>I</sub> = 5.5 V                      |     |         | 10    |      |       | 10         |      |
| ١.                | Control inputs | $V_{CC} = 3.6 \text{ V},$   | $V_I = V_{CC}$ or GND                       |     |         | ±1    |      |       | ±1         | 4    |
| lı                | 5              | Vaa 26V   | VI = VCC                                    |     |         | 1     |      |       | 1          | μΑ   |
|                   | Data inputs    | VCC = 3.6 V   | V <sub>I</sub> = 0                          |     | -5      |       |      | -5    |            |      |
| l <sub>off</sub>  |                | $V_{CC} = 0$ ,  | $V_{I}$ or $V_{O} = 0$ to 4.5 V             |     |         | _     |      |       | ±100       | μΑ   |
| lozh              |                | $V_{CC} = 3.6 \text{ V},$   | V <sub>O</sub> = 3 V                        |     | Á       | 5     |      |       | 5          | μΑ   |
| lozL              |                | $V_{CC} = 3.6 \text{ V},$   | V <sub>O</sub> = 0.5 V                      |     | F       | -5    |      |       | <b>-</b> 5 | μΑ   |
| lozpu             |                | $\frac{\text{VCC}}{\text{OE}} = 0 \text{ to } 1.5 \text{ V, VO} = 0$                | = 0.5 V to 3 V,                             |     | CY      | ±100* |      |       | ±100       | μΑ   |
| lozpd             |                | $\frac{V_{CC}}{OE}$ = 1.5 V to 0, V <sub>O</sub> = $\frac{V_{CC}}{OE}$ = don't care | = 0.5 V to 3 V,                             | 20° | 2       | ±100* |      |       | ±100       | μΑ   |
|                   |                | V <sub>CC</sub> = 3.6 V,  | Outputs high                                | Q   |         | 0.19  |      |       | 0.19       |      |
| ICC               |                | $I_{O} = 0$ ,   | Outputs low                                 |     |         | 5     |      |       | 5          | mA   |
|                   |                | VI = VCC or GND   | Outputs disabled                            |     |         | 0.19  | 0.19 |       |            |      |
| ∆lcc <sup>‡</sup> |                | $V_{CC} = 3 \text{ V to } 3.6 \text{ V, On}$<br>Other inputs at $V_{CC}$ or         | ne input at V <sub>CC</sub> – 0.6 V,<br>GND |     |         | 0.2   |      |       | 0.2        | mA   |
| Ci                |                | V <sub>I</sub> = 3 V or 0   |   |     | 4       |       |      | 4     |            | pF   |
| Со                |                | $V_O = 3 \text{ V or } 0$   |   |     | 9       |       |      | 9     |            | pF   |

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.



<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>‡</sup>This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

## SN54LVT162240, SN74LVT162240 3.3-V ABT 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

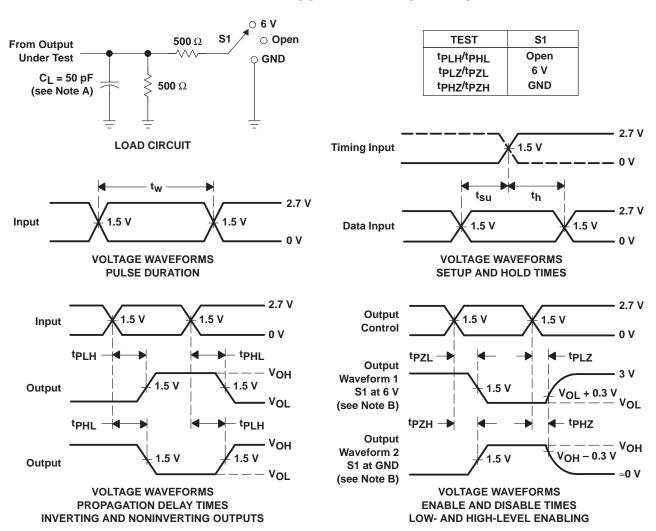
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# switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

|                  |                 | TO<br>(OUTPUT) | SN54LVT162240 |     |                         |     | SN74LVT162240                      |                  |     |                         |     |      |
|------------------|-----------------|----------------|---------------|-----|-------------------------|-----|------------------------------------|------------------|-----|-------------------------|-----|------|
| PARAMETER        | FROM<br>(INPUT) |                | 00 .          |     | V <sub>CC</sub> = 2.7 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |                  |     | V <sub>CC</sub> = 2.7 V |     | UNIT |
|                  |                 |                | MIN           | MAX | MIN                     | MAX | MIN                                | TYP <sup>†</sup> | MAX | MIN                     | MAX |      |
| t <sub>PLH</sub> | Α               | Y              | 1             | 4.2 | 2                       | 5   | 1                                  | 2.5              | 4   |                         | 4.6 | ns   |
| t <sub>PHL</sub> | A               | Ť              | 1             | 4.2 | 4/                      | 5   | 1                                  | 2.9              | 4   |                         | 4.6 | 115  |
| <sup>t</sup> PZH | ŌĒ              | Y              | 1             | 5   | Y'E                     | 5.5 | 1                                  | 2.8              | 4.8 |                         | 5.7 | ns   |
| t <sub>PZL</sub> | OE              | '              | 1             | 4.9 | 7,                      | 5.1 | 1                                  | 2.8              | 4.7 |                         | 4.9 | 115  |
| <sup>t</sup> PHZ |                 | <b>V</b>       | 1.9           | 4.9 |                         | 5.4 | 2                                  | 3.5              | 4.7 |                         | 5.2 | ns   |
| t <sub>PLZ</sub> | ŌĒ              | 1              | 1.9           | 4.7 |                         | 4.8 | 2                                  | 3.4              | 4.5 |                         | 4.5 | 115  |
| tsk(o)           |                 |                |               | Q   |                         |     |                                    |                  | 0.5 |                         | ·   | ns   |

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_{O}$  = 50  $\Omega$ ,  $t_{f} \leq$  2.5 ns,  $t_{f} \leq$  2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





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#### **PACKAGING INFORMATION**

| Orderable Device  | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan <sup>(2)</sup>    | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|-------------------|-----------------------|-----------------|--------------------|------|----------------|----------------------------|------------------|------------------------------|
| 74LVT162240DGGRE4 | ACTIVE                | TSSOP           | DGG                | 48   | 2000           | Pb-Free<br>(RoHS)          | CU NIPDAU        | Level-1-250C-UNLIM           |
| 74LVT162240DGVRE4 | ACTIVE                | TVSOP           | DGV                | 48   | 2000           | Pb-Free<br>(RoHS)          | CU NIPDAU        | Level-1-250C-UNLIM           |
| SN74LVT162240DGGR | ACTIVE                | TSSOP           | DGG                | 48   | 2000           | Pb-Free<br>(RoHS)          | CU NIPDAU        | Level-1-250C-UNLIM           |
| SN74LVT162240DGVR | ACTIVE                | TVSOP           | DGV                | 48   | 2000           | Pb-Free<br>(RoHS)          | CU NIPDAU        | Level-1-250C-UNLIM           |
| SN74LVT162240DL   | ACTIVE                | SSOP            | DL                 | 48   | 25             | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVT162240DLR  | ACTIVE                | SSOP            | DL                 | 48   | 1000           | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## DGV (R-PDSO-G\*\*)

#### **24 PINS SHOWN**

#### **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

#### DL (R-PDSO-G\*\*)

#### **48 PINS SHOWN**

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118

## DGG (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

#### **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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| Microcontrollers | microcontroller.ti.com | Security           | www.ti.com/security       |
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